

MOSFET

600V CoolMOS™ SJ S7TA Power Device

CoolMOS™ S7TA enables the best price performance for low-frequency switching applications. The embedded temperature sensor increases junction temperature sensing accuracy and robustness while keeping an easy and seamless implementation. CoolMOS™ S7TA is optimized for “static switching” and high current applications. The new temperature sensor enhances S7A features, allowing the best possible utilization of the power transistor.

Features

- Optimized price performance in low-frequency switching applications
- High pulse current capability
- Seamless diagnostics at lowest system cost
- Temperature sense feature for protection and optimized thermal device utilization

Benefits

- Reduction of external sensing elements, hence a more compact design compared to electromechanical devices
- Increased system performance
- Minimized conduction losses (reduce heat sink size)
- More reliability and longer system lifetime
- Shock & Vibration resistance; No contact arcing or bouncing

Potential applications

- Circuit breakers (HV eDisconnect switch, DC and AC low frequency switch, HV eFuse, on-board charger)
- Line rectification in high-power/performance applications

Product validation

Qualified according to AEC Q101

Please note: The source and sense source pins are not exchangeable. Their exchange might lead to malfunction. For paralleling 4pin MOSFET devices the placement of the gate resistor is generally recommended to be on the Driver Source instead of the Gate. For production part approval process (PPAP) release we propose to share application related information during an early design phase to avoid delays in PPAP release. Please contact Infineon sales office.

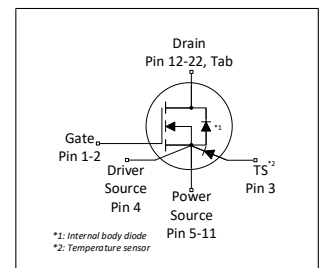
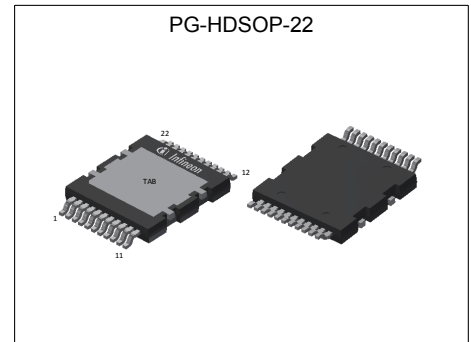


Table 1 Key Performance Parameters

Parameter	Value	Unit
$R_{DS(on),max}$	22	mΩ
$Q_{g,typ}$	150	nC
V_{SD}	0.82	V
Pulsed I_{SD}, I_{DS}	371	A
ESD class (HBM)	2	JEDEC AEC Q101

Type / Ordering Code	Package	Marking	Related Links
IPDQ60T022S7A	PG-HDSOP-22	60T022S7	see Appendix A

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1 Maximum ratings

at $T_j = 25^\circ\text{C}$, unless otherwise specified

Table 2 Maximum MOSFET ratings

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Drain current rating ¹⁾	I_D	-	-	90 24	A	$T_C=25^\circ\text{C}$ $T_C=140^\circ\text{C}$
Pulsed drain current ²⁾	$I_{D,pulse}$	-	-	371	A	$T_C=25^\circ\text{C}$
Avalanche energy, single pulse	E_{AS}	-	-	286	mJ	$I_D=3.7\text{A}$; $V_{DD}=50\text{V}$; see table 11
Avalanche current, single pulse	I_{AS}	-	-	3.7	A	-
MOSFET dv/dt ruggedness ³⁾	dv/dt	-	-	20	V/ns	$V_{DS}=0\text{V to }300\text{V}$
Gate source voltage (static)	V_{GS}	-20	-	20	V	static
Gate source voltage (dynamic)	V_{GS}	-30	-	30	V	AC ($f>1\text{ Hz}$)
Power dissipation	P_{tot}	-	-	416	W	$T_C=25^\circ\text{C}$
Storage temperature	T_{stg}	-55	-	150	$^\circ\text{C}$	-
Operating junction temperature ¹⁾	T_j	-40	-	150	$^\circ\text{C}$	-
Extended operating junction temperature	T_j	150	-	175	$^\circ\text{C}$	$\leq 50\text{ h}$ in the application lifetime
Mounting torque	-	-	-	n.a.	Ncm	-
Diode forward current rating	I_S	-	-	24	A	$T_C=140^\circ\text{C}$ Current is limited by $T_{j,max} = 150^\circ\text{C}$; Lower case temp does increase current capability
Diode pulse current ¹⁾	$I_{S,pulse}$	-	-	371	A	$T_C=25^\circ\text{C}$
Reverse diode dv/dt ⁴⁾	dv/dt	-	-	5	V/ns	$V_{DS}=0\text{ to }300\text{V}$, $I_{SD}\leq 23\text{A}$, $T_j=25^\circ\text{C}$ see table 9
Maximum diode commutation speed	di/dt	-	-	800	A/ μs	$V_{DS}=0\text{ to }300\text{V}$, $I_{SD}\leq 23\text{A}$, $T_j=25^\circ\text{C}$ see table 9
Insulation withstand voltage	V_{ISO}	-	-	n.a.	V	-

¹⁾ Please consider the App Note: 600 V CoolMOS™ S7 with Temperature Sense for high delta T_j usage

²⁾ Pulse width t_p limited by $T_{j,max}$

³⁾ The dv/dt has to be limited by appropriate gate resistor

⁴⁾ Identical low side and high side switch

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Thermal resistance, junction - case	R_{thJC}	-	-	0.3	°C/W	-
Thermal resistance, junction - ambient	R_{thJA}	-	-	62	°C/W	device on PCB, minimal footprint
Thermal resistance, junction - ambient for SMD version	R_{thJA}	-	45	55	°C/W	Device on 40mm*40mm*1.5mm epoxy PCB FR4 with 6cm ² (one layer, 70µm thickness) copper area. Tap exposed to air. PCB is vertical without air stream cooling.
Soldering temperature, reflow soldering allowed	T_{sold}	-	-	260	°C	reflow MSL1

3 Electrical characteristics

at $T_j=25^\circ\text{C}$, unless otherwise specified

Table 4 Static characteristics

The CoolMOS™ mentioned in this datasheet shall not be operated in linear mode.

For any questions in this regard, please contact Infineon sales office.

For applications with applied blocking voltage >400V, it is required that the customer evaluates the impact of cosmic radiation effect in early design phase and contacts the Infineon sales office for the necessary technical support by Infineon

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Drain-source breakdown voltage	$V_{(BR)DSS}$	600	-	-	V	$V_{GS}=0V$, $I_D=1mA$
Gate threshold voltage	$V_{(GS)th}$	3.5	4.0	4.5	V	$V_{DS}=V_{GS}$, $I_D=1.43mA$
Zero gate voltage drain current	I_{DSS}	-	-	5	μA	$V_{DS}=600V$, $V_{GS}=0V$, $T_j=25^\circ\text{C}$ $V_{DS}=600V$, $V_{GS}=0V$, $T_j=150^\circ\text{C}$
Gate-source leakage current	I_{GSS}	-	-	100	nA	$V_{GS}=20V$, $V_{DS}=0V$
Drain-source on-state resistance	$R_{DS(on)}$	-	0.02	0.022	Ω	$V_{GS}=12V$, $I_D=23A$, $T_j=25^\circ\text{C}$ $V_{GS}=12V$, $I_D=23A$, $T_j=150^\circ\text{C}$
Gate resistance	R_G	-	0.8	-	Ω	$f=1MHz$, open drain

Table 5 Dynamic characteristics

External parasitic elements (PCB layout) influence switching behavior significantly.

Stray inductances and coupling capacitances must be minimized.

For layout recommendations please use provided application notes or contact Infineon sales office.

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Input capacitance	C_{iss}	-	5640	-	pF	$V_{GS}=0V$, $V_{DS}=300V$, $f=250kHz$
Output capacitance	C_{oss}	-	89	-	pF	$V_{GS}=0V$, $V_{DS}=300V$, $f=250kHz$
Effective output capacitance, energy related ¹⁾	$C_{o(er)}$	-	302	-	pF	$V_{GS}=0V$, $V_{DS}=0$ to 300V
Effective output capacitance, time related ²⁾	$C_{o(tr)}$	-	2677	-	pF	$I_D=\text{constant}$, $V_{GS}=0V$, $V_{DS}=0$ to 300V
Output charge	Q_{oss}	-	803	-	nC	$V_{GS}=0V$, $V_{DS}=0$ to 300V
Turn-on delay time	$t_{d(on)}$	-	30	-	ns	$V_{DD}=300V$, $V_{GS}=13V$, $I_D=23A$, $R_G=5.3\Omega$; see table 9
Rise time	t_r	-	6	-	ns	$V_{DD}=300V$, $V_{GS}=13V$, $I_D=23A$, $R_G=5.3\Omega$; see table 9
Turn-off delay time	$t_{d(off)}$	-	142	-	ns	$V_{DD}=300V$, $V_{GS}=13V$, $I_D=23A$, $R_G=5.3\Omega$; see table 9
Fall time	t_f	-	10	-	ns	$V_{DD}=300V$, $V_{GS}=13V$, $I_D=23A$, $R_G=5.3\Omega$; see table 9

¹⁾ $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 300V

²⁾ $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 300V

Table 6 Gate charge characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Gate to source charge	Q_{gs}	-	31	-	nC	$V_{DD}=300V$, $I_D=23A$, $V_{GS}=0$ to $12V$
Gate to drain charge	Q_{gd}	-	49	-	nC	$V_{DD}=300V$, $I_D=23A$, $V_{GS}=0$ to $12V$
Gate charge total	Q_g	-	150	-	nC	$V_{DD}=300V$, $I_D=23A$, $V_{GS}=0$ to $12V$
Gate plateau voltage	$V_{plateau}$	-	5.4	-	V	$V_{DD}=300V$, $I_D=23A$, $V_{GS}=0$ to $12V$

Table 7 Reverse diode characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Diode forward voltage	V_{SD}	-	0.82	-	V	$V_{GS}=0V$, $I_F=23A$, $T_j=25^\circ C$
Reverse recovery time	t_{rr}	-	410	-	ns	$V_R=300V$, $I_F=23A$, $di_F/dt=100A/\mu s$; see table 8
Reverse recovery charge	Q_{rr}	-	10	-	μC	$V_R=300V$, $I_F=23A$, $di_F/dt=100A/\mu s$; see table 8
Peak reverse recovery current	I_{rrm}	-	48	-	A	$V_R=300V$, $I_F=23A$, $di_F/dt=100A/\mu s$; see table 8

4 Temperature Sensor parameters

at $T_j=25^\circ\text{C}$, unless otherwise specified

Table 8 Maximum ratings

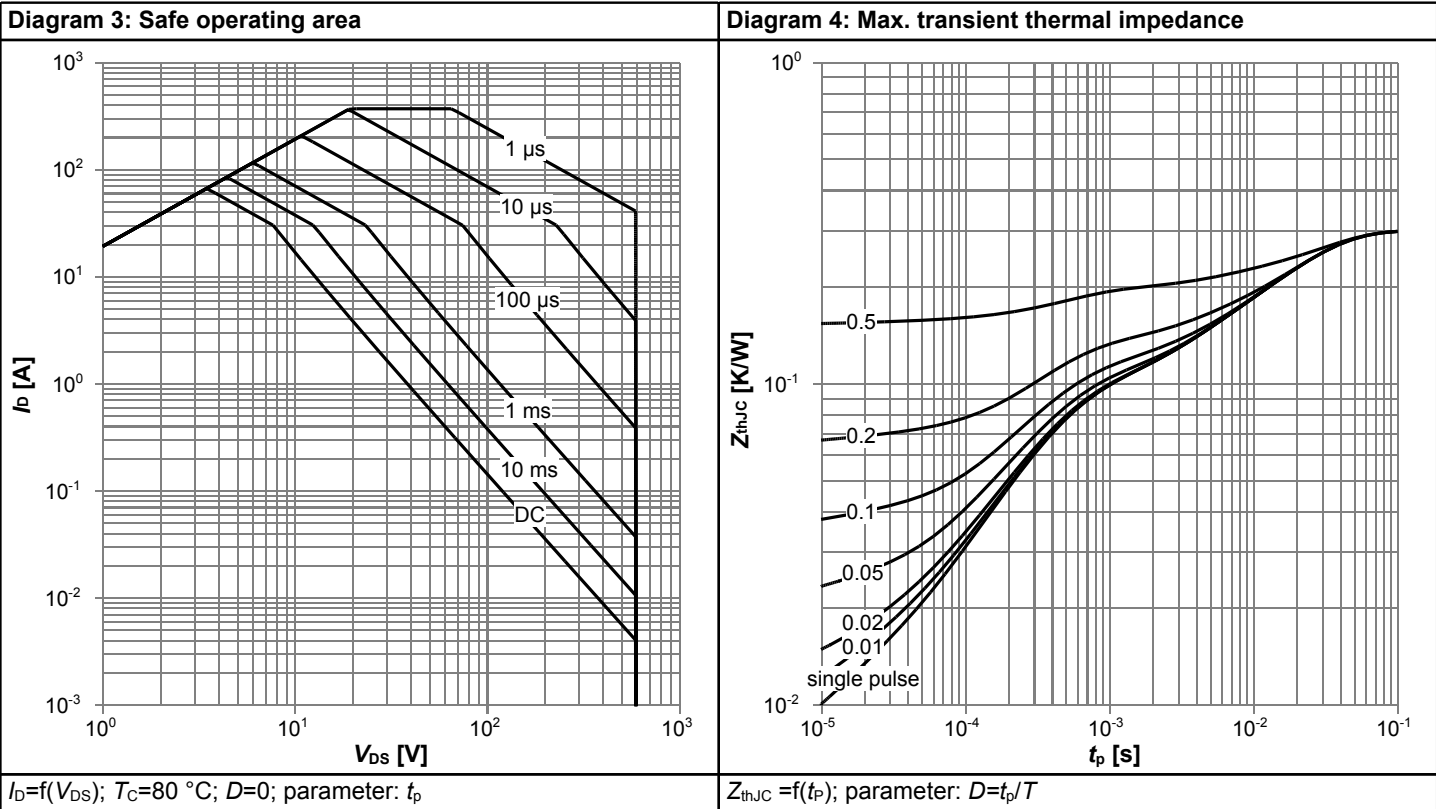
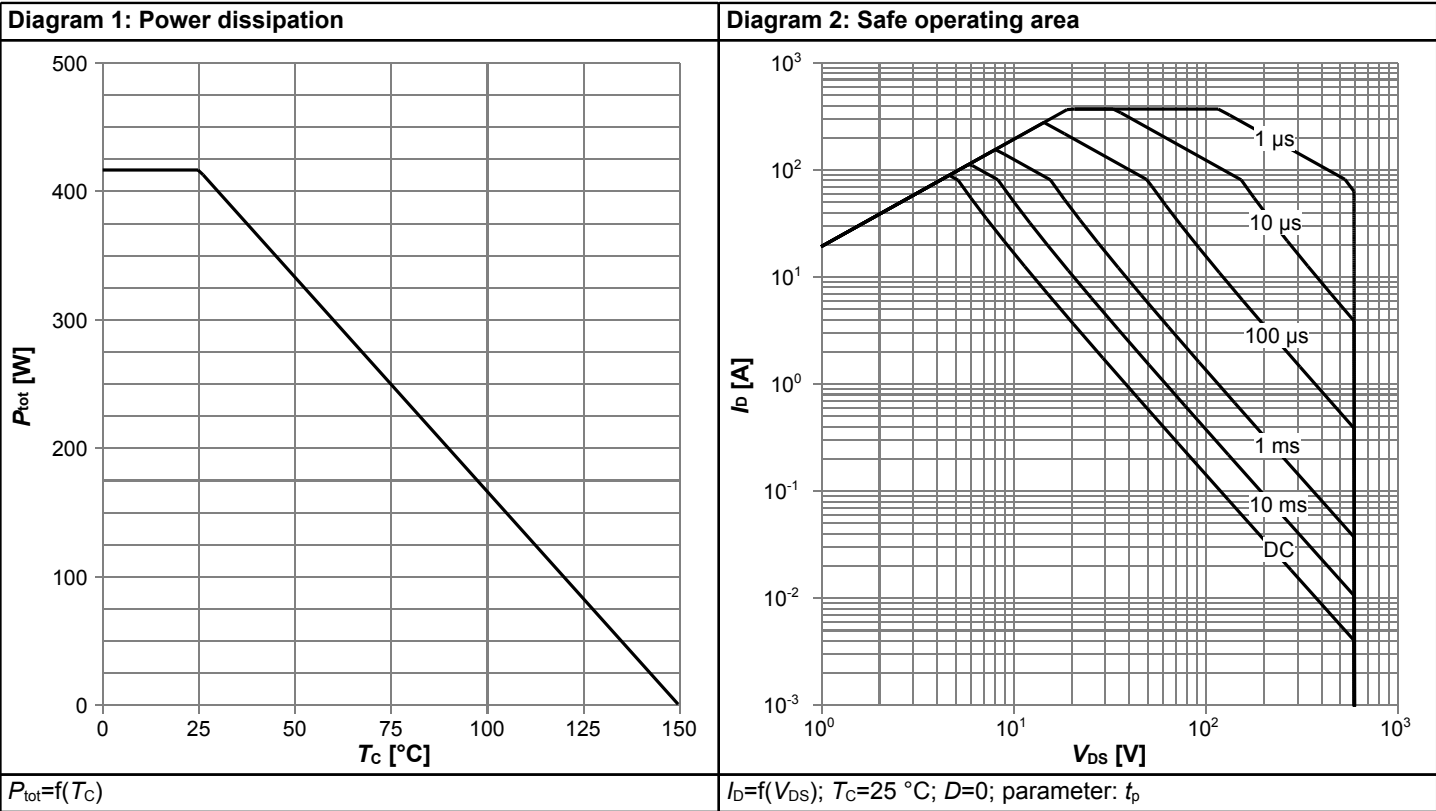
Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Repetitive Peak Reverse Voltage	V_{RRM}	-	-	15	V	$I_R = 100 \mu\text{A}$
Sensor forward current	I_F	-	-	5	mA	-
Repetitive peak forward current	I_{F_pulse}	-	-	25	mA	$t_{pulse} = 1 \text{ ms}$, $T_{period} = 10 \text{ ms}$
Non-repetitive peak forward current	I_{FSM}	-	-	1.5 0.2 0.1	A	$T_C = 25^\circ\text{C}$, $t_{pulse} = 1 \mu\text{s}$ $T_C = 25^\circ\text{C}$, $t_{pulse} = 1 \text{ ms}$ $T_C = 25^\circ\text{C}$, $t_{pulse} = 1 \text{ s}$
Junction Temperature	T_j	-	-	185	$^\circ\text{C}$	$t < 50\text{h}$, Sensor only

Table 9 Electrical characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Sensor forward voltage ¹⁾	V_{F_25}	1.5601 - - 2.0665	1.6019 1.8103 1.9806 2.0966	1.6436 - - 2.1266	V	$T_j = 25^\circ\text{C}$, $I_F = 10 \mu\text{A}$ $T_j = 25^\circ\text{C}$, $I_F = 50 \mu\text{A}$ $T_j = 25^\circ\text{C}$, $I_F = 200 \mu\text{A}$ $T_j = 25^\circ\text{C}$, $I_F = 500 \mu\text{A}$
Sensor forward voltage temperature coefficient	TC	- - - -	5.9644 5.5880 5.2287 5.0135	- - - -	mV/K	$25^\circ\text{C} \leq T_j \leq 175^\circ\text{C}$, $I_F = 10 \mu\text{A}$ $25^\circ\text{C} \leq T_j \leq 175^\circ\text{C}$, $I_F = 50 \mu\text{A}$ $25^\circ\text{C} \leq T_j \leq 175^\circ\text{C}$, $I_F = 200 \mu\text{A}$ $25^\circ\text{C} \leq T_j \leq 175^\circ\text{C}$, $I_F = 500 \mu\text{A}$
Sensor forward voltage	V_{F_175}	0.6655 - - 1.3144	0.7072 0.9721 1.1963 1.3445	0.7490 - - 1.3746	V	$T_j = 175^\circ\text{C}$, $I_F = 10 \mu\text{A}$ $T_j = 175^\circ\text{C}$, $I_F = 50 \mu\text{A}$ $T_j = 175^\circ\text{C}$, $I_F = 200 \mu\text{A}$ $T_j = 175^\circ\text{C}$, $I_F = 500 \mu\text{A}$
Reverse leakage current	I_R	- -	- -	1 20	μA	$V_R = 10\text{V}$, $T_j = 25^\circ\text{C}$ $V_R = 10\text{V}$, $T_j = 175^\circ\text{C}$
Sensor G Capacitance	C_{GTS}	-	4.2	-	pF	$f = 1 \text{ MHz}$, $I_F = 50 \mu\text{A}$
Sensor Capacitance	C_{STS}	-	4.8	-	pF	$f = 1 \text{ MHz}$, $I_F = 50 \mu\text{A}$
Anode-Drain Capacitance	C_{DTS}	-	0.5	-	pF	$f = 1 \text{ MHz}$, $V_{DS} = 0 \text{ V}$

¹⁾ Specified by Design and not tested

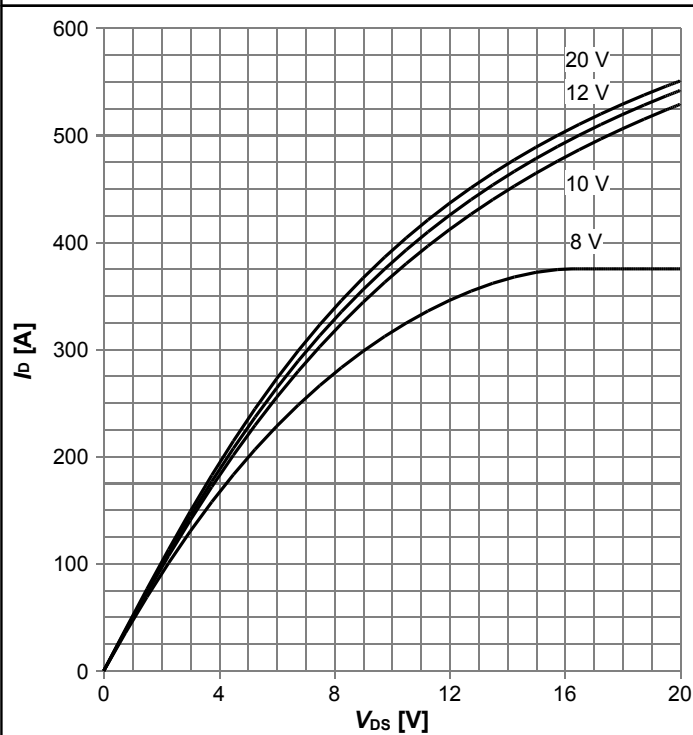
5 Electrical characteristics diagrams



600V CoolMOS™ SJ S7TA Power Device

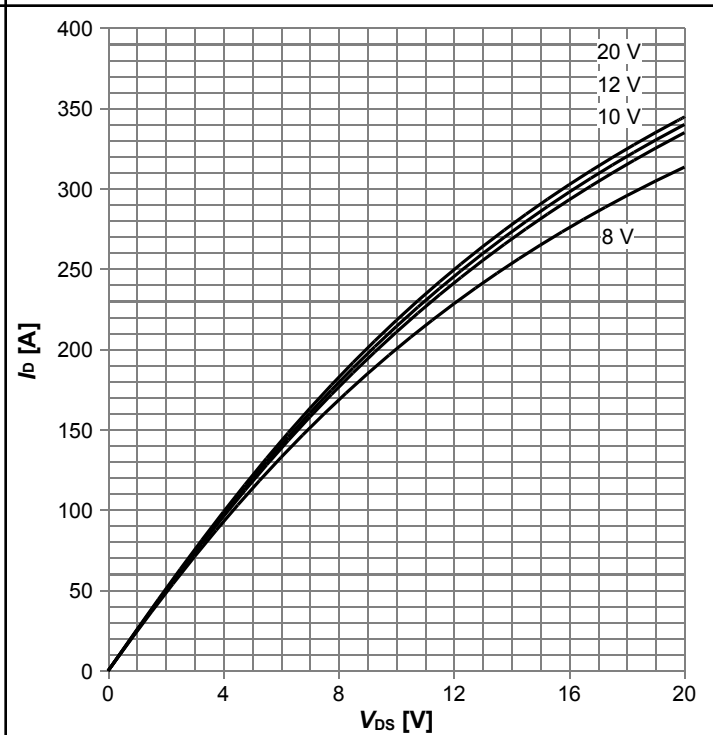
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Diagram 5: Typ. output characteristics



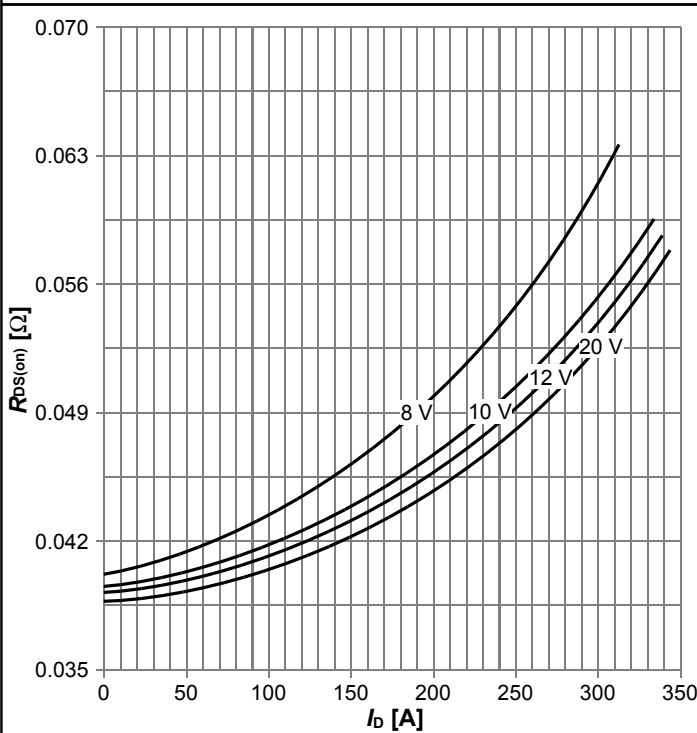
$I_D = f(V_{DS})$; $T_J = 25\text{ °C}$; parameter: V_{GS}

Diagram 6: Typ. output characteristics



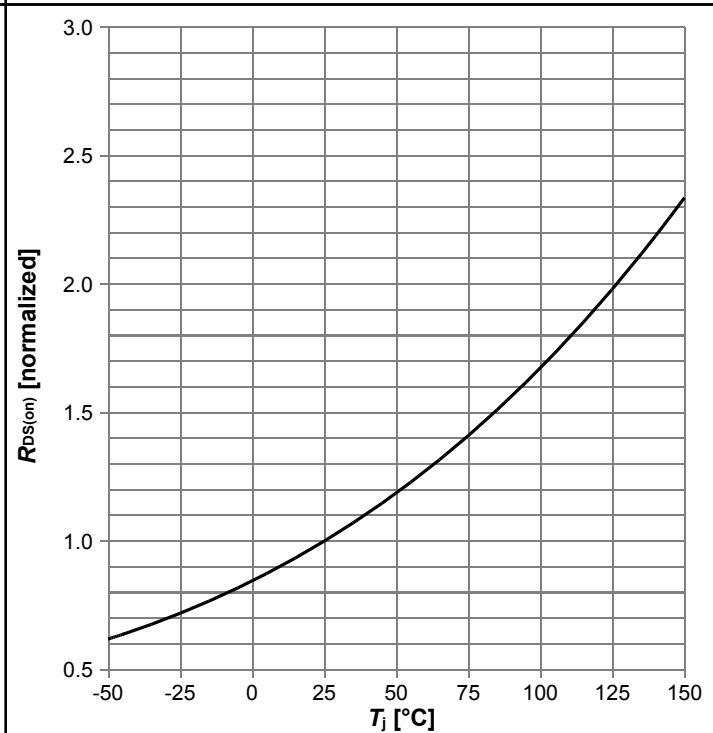
$I_D = f(V_{DS})$; $T_J = 125\text{ °C}$; parameter: V_{GS}

Diagram 7: Typ. drain-source on-state resistance



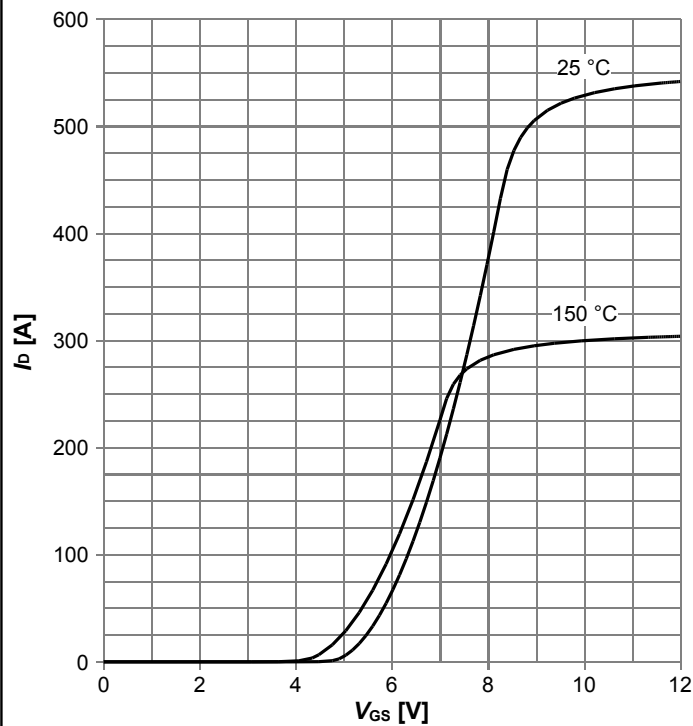
$R_{DS(on)} = f(I_D)$; $T_J = 125\text{ °C}$; parameter: V_{GS}

Diagram 8: Drain-source on-state resistance



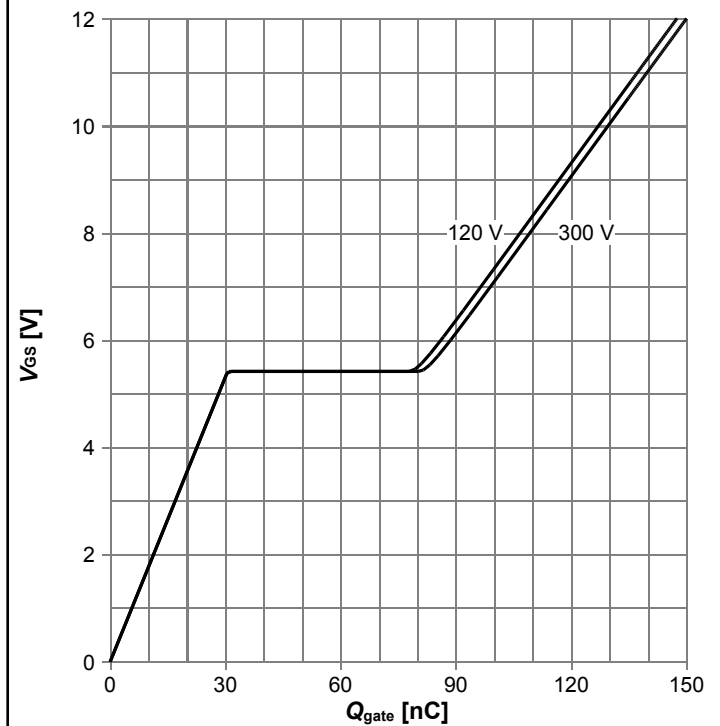
$R_{DS(on)} = f(T_J)$; $I_D = 23\text{ A}$; $V_{GS} = 12\text{ V}$

Diagram 9: Typ. transfer characteristics



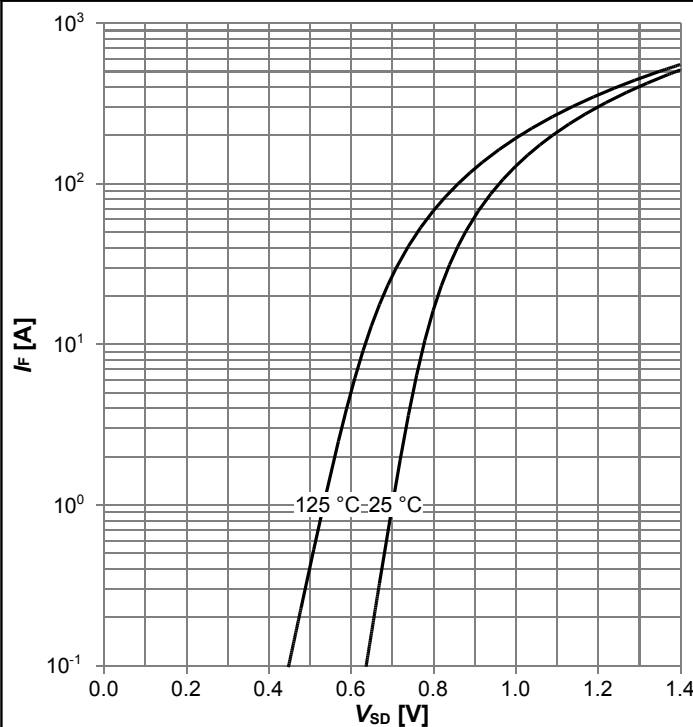
$I_D=f(V_{GS})$; $V_{DS}=20V$; parameter: T_j

Diagram 10: Typ. gate charge



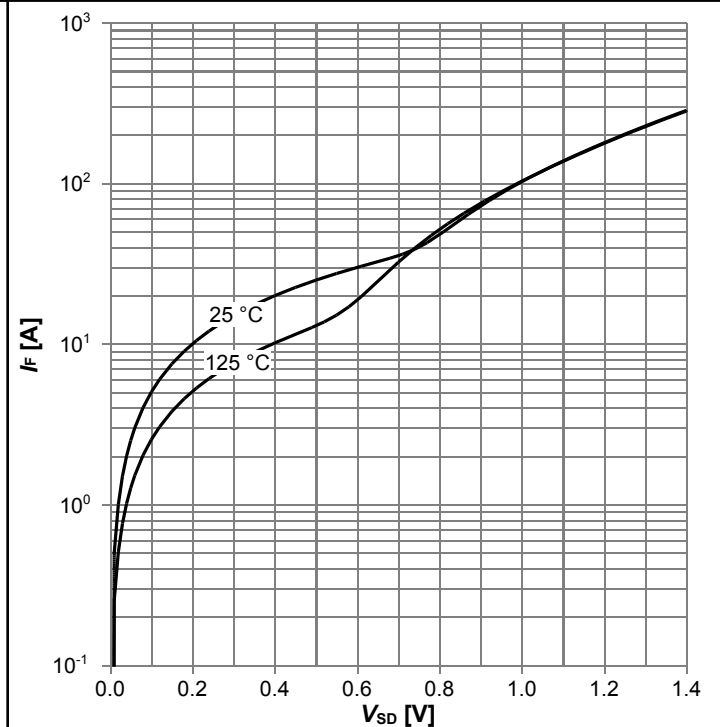
$V_{GS}=f(Q_{gate})$; $I_D=23\text{ A}$ pulsed; parameter: V_{DD}

Diagram 11: Forward characteristics of reverse diode



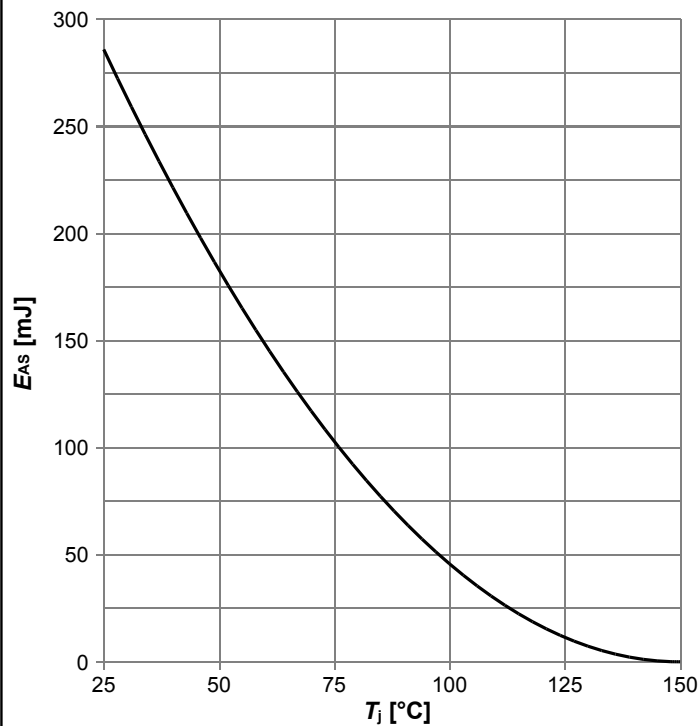
$I_F=f(V_{SD})$; $V_{GS}=0\text{ V}$; parameter: T_j

Diagram 12: Forward characteristics of reverse diode



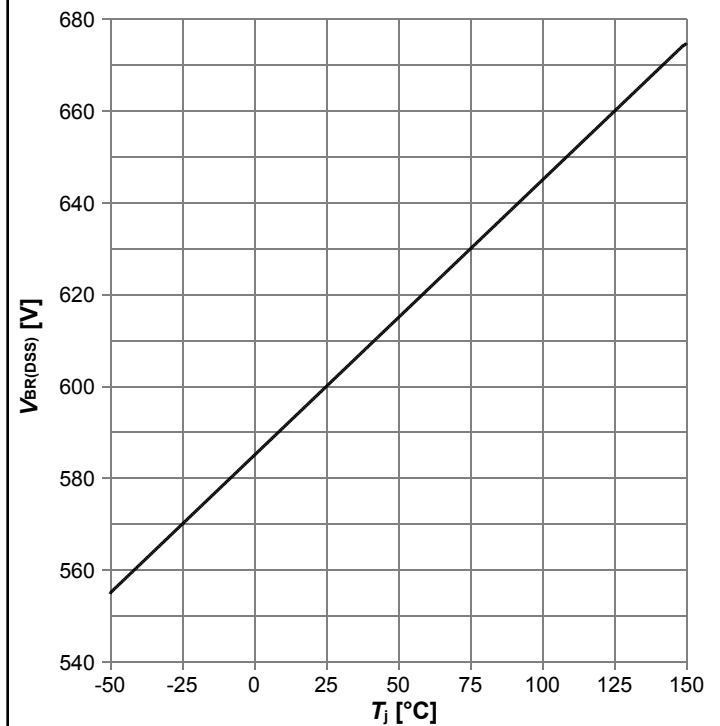
$I_F=f(V_{SD})$; $V_{GS}=12\text{ V}$; parameter: T_j

Diagram 13: Avalanche energy



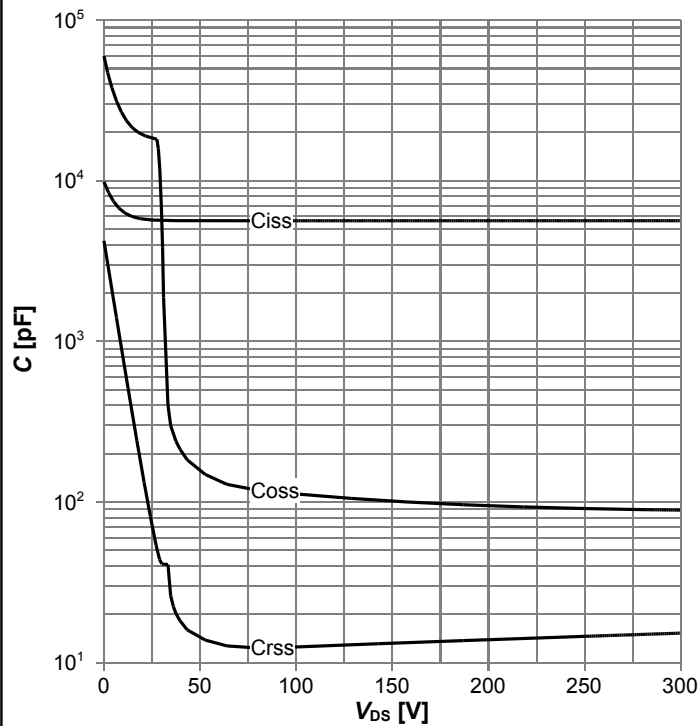
$E_{AS}=f(T_J)$; $I_D=3.7$ A; $V_{DD}=50$ V

Diagram 14: Drain-source breakdown voltage



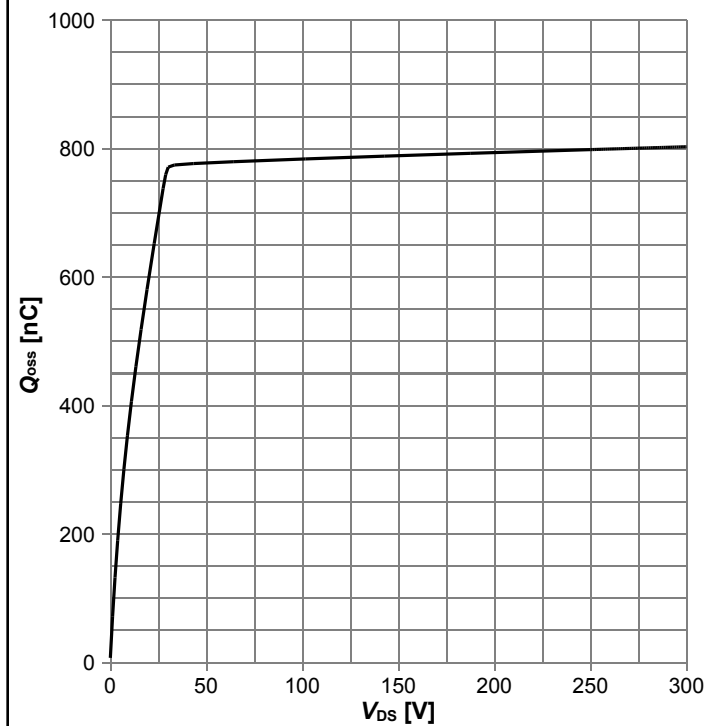
$V_{BR(DSS)}=f(T_J)$; $I_D=1$ mA

Diagram 15: Typ. capacitances



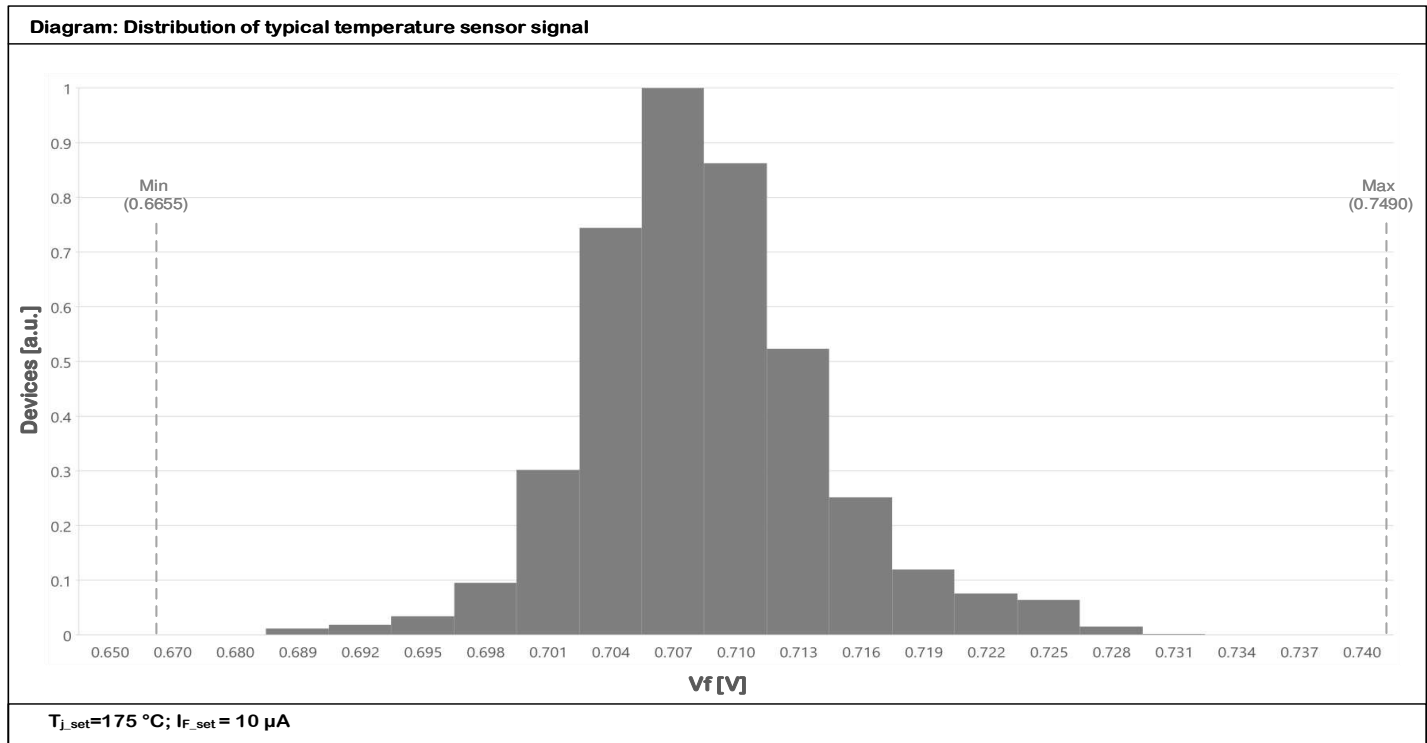
$C=f(V_{DS})$; $V_{GS}=0$ V; $f=250$ kHz

Diagram 17: Typ. Qoss output charge



$Q_{oss}=f(V_{DS})$; $V_{GS}=0$ V

600V CoolMOS™ SJ S7TA Power Device
IPDQ60T022S7A



6 Test Circuits

Table 10 Diode characteristics

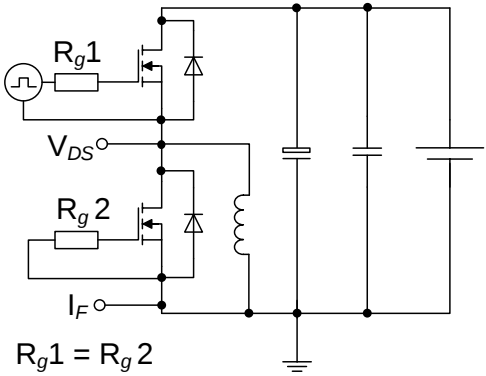
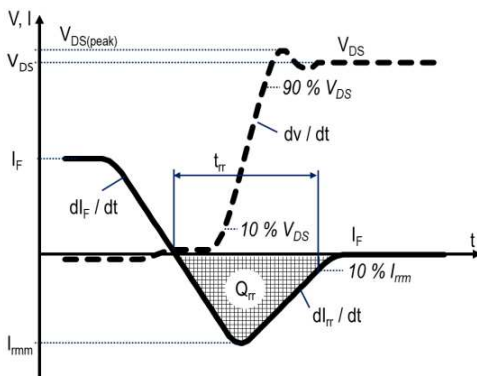
Test circuit for diode characteristics	Diode recovery waveform
 $R_{g1} = R_{g2}$	

Table 11 Switching times (ss)

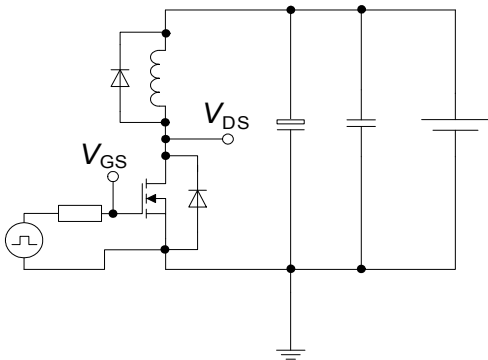
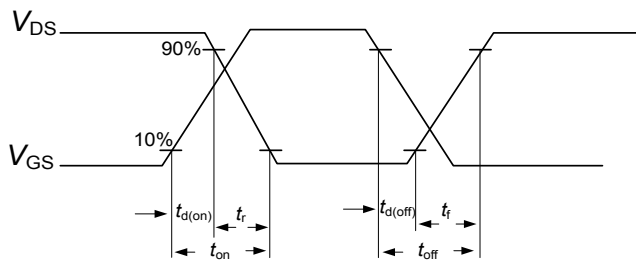
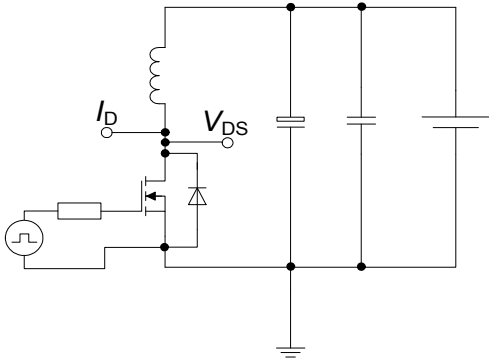
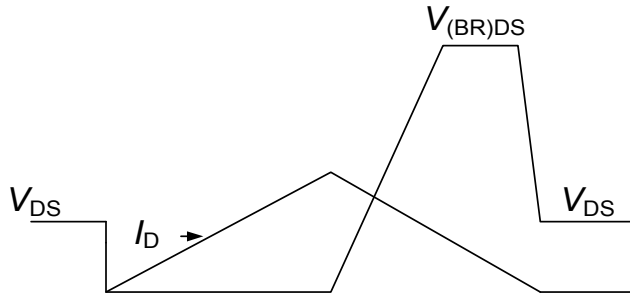
Switching times test circuit for inductive load	Switching times waveform
	

Table 12 Unclamped inductive load (ss)

Unclamped inductive load test circuit	Unclamped inductive waveform
	

7 Package Outlines

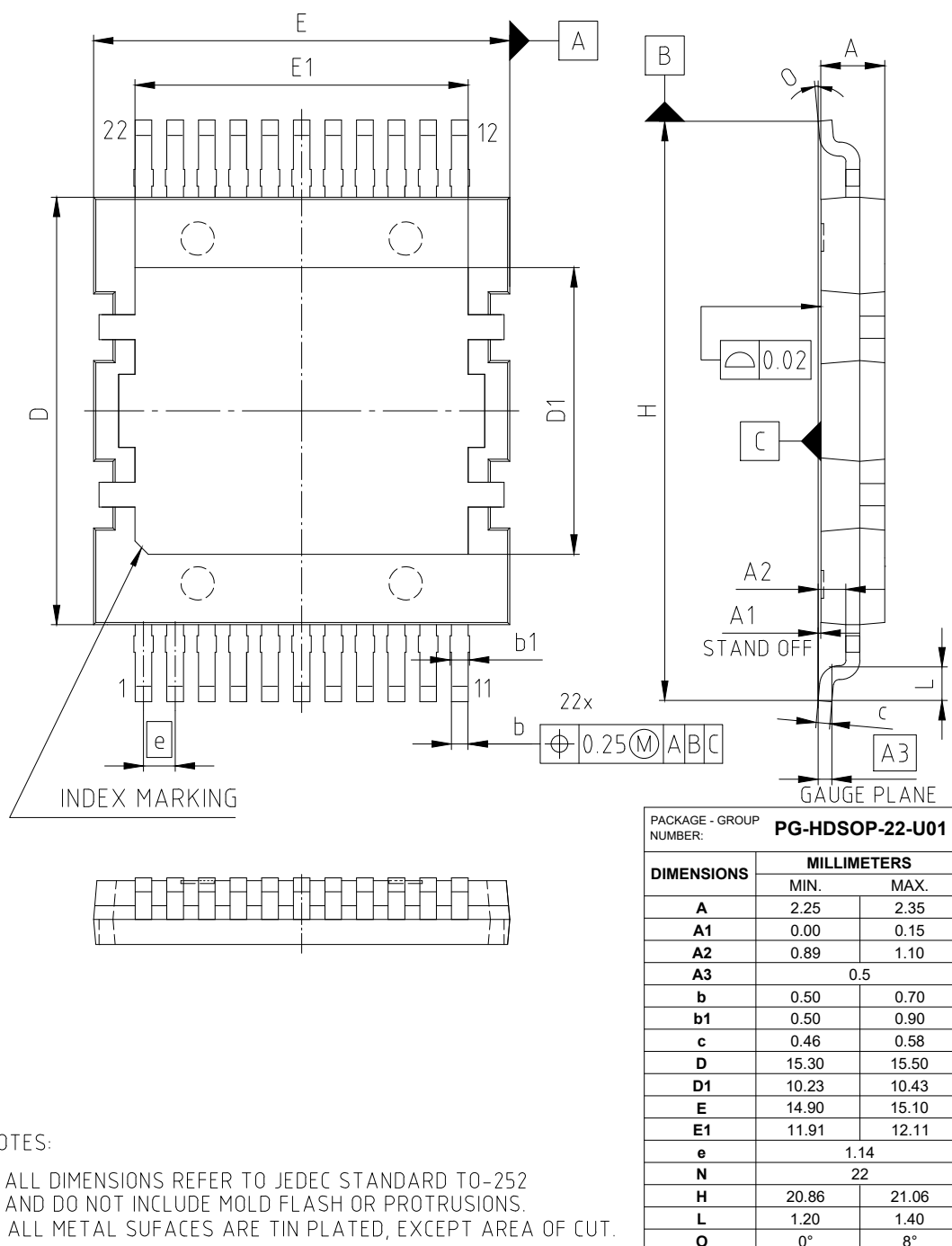


Figure 1 Outline PG-HDSOP-22, dimensions in mm

8 Appendix A

Table 13 Related Links

- IFX CoolMOS™ S7TA Webpage: www.infineon.com
- IFX CoolMOS™ S7TA application note: www.infineon.com
- IFX CoolMOS™ S7TA simulation model: www.infineon.com
- IFX Design tools: www.infineon.com

Revision History

IPDQ60T022S7A

Revision: 2023-11-30, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2023-11-30	Release of final version

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Published by

Infineon Technologies AG

81726 München, Germany

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[2SK2614\(Te16L1,Q\)](#) [JANTX2N6798](#) [DMN1017UCP3-7](#) [EFC2J004NUZTDG](#) [DMN1053UCP4-7](#) [SCM040600](#) [NTE2384](#) [2N7000TA](#)
[DMN2080UCB4-7](#) [DMN61D9UWQ-13](#) [US6M2GTR](#) [DMN31D5UDJ-7](#) [DMP22D4UFO-7B](#) [DMN1006UCA6-7](#) [DMN16M9UCA6-7](#)
[STF5N65M6](#) [IRF40H233XTMA1](#) [STU5N65M6](#) [DMN6022SSD-13](#) [DMN13M9UCA6-7](#) [DMTH10H4M6SPS-13](#) [DMN2990UFB-7B](#)
[2N7002W-G](#) [MCAC30N06Y-TP](#) [MCQ7328-TP](#) [IPB45P03P4L11ATMA2](#) [BXP2N20L](#) [BXP2N65D](#) [BXT330N06D](#) [TSM60NB380CP](#) [ROG](#)
[RQ7L055BGTCTCR](#) [SLF10N65ABV2](#)